# SP8714



# 2100MHz Very Low Current Multi-Modulus Divider

DS3562 - 5.1 April 1999

The SP8714 is a switchable divide by 32/33, 64/65 programmable divider which is guaranteed to operate up to 2100MHz. It will operate from a supply of 2.7V to 5.25V and requires typically 6.8mA (including the output current). It also features a power down facility for battery economy.

The RF inputs are internally biased and should be capacitively coupled to the signal source. The output is designed to interface with CMOS synthesisers.

# **FEATURES**

- Operation to 2100MHz
- Very Low Power
- Single Supply Operation 2.7V to 5.25V
- Power Down Facility for Battery Economy
- Latched Modulus Control Input
- Push Pull Output Drive
- ESD Protection on All Pins<sup>†</sup>

# **APPLICATIONS**

- Cellular Telephones
- Cordless Telephones

<sup>†</sup> ESD precautions must be observed

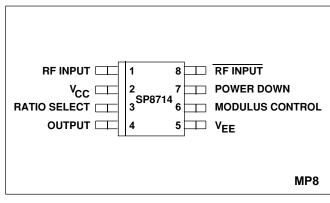
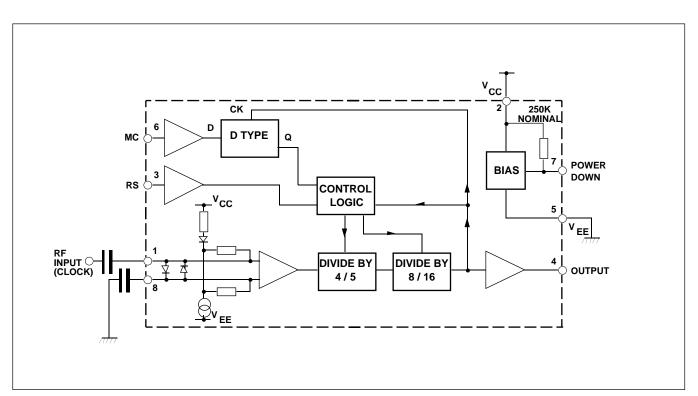


Fig. 1 Pin connections - top view

#### **ORDERING INFORMATION**

SP8714 IG MPAS Industrial Temperature Range Miniature Plastic SOIC Package SP8714 IG MPAC As above supplied on Tape and Reel



# SP8714

## **ABSOLUTE MAXIMUM RATINGS**

Supply voltage (V <sub>EE</sub> =0V)	(note 1)	-0.5V to 7V
Control and RF inputs,		
RF output (V <sub>EE</sub> =0V)	(note 1)	-0.5V to V <sub>CC</sub> +0.5V
RF input current	(note 1)	10mA
Operating temperature		-40°C to +85°C
Storage temperature range		-55°C to +150°C
Maximum junction temperatu	re	+150°C
NOTE 1. Duration <2 minutes.		

#### **ELECTRICAL CHARACTERISTICS**

#### Guaranteed over the following conditions (unless otherwise stated):

V<sub>CC</sub>=+2.7V to +5.25V (with respect to V<sub>EE</sub>), Output load (pin 4) = 10pF, T<sub>amb</sub> = -40°C to +85°C (note 2)

		Value	_		•		
Characterist	liC	Min.	Тур.	Max.	Units	Conditions	
Supply current	(note 3)		6.8	8.5	mA	Power down input low	
Supply current	(note 3)		8	50	μA	Power down input high	
Power down high		V <sub>CC</sub> -0.5		V <sub>CC</sub>	V		
Power down low		0		V <sub>CC</sub> -2.0	V		
Modulus control high	(note 4)	0.6V <sub>CC</sub>		V <sub>CC</sub>	V	Divide by 32 or 64	
Modulus control low	(note 4)	0		0.4V <sub>CC</sub>	V	Divide by 33 or 65	
Ratio select high	(note 4, 9)	0.6V <sub>CC</sub>		V <sub>CC</sub>	V	Divide by 32 or 33	
Ratio select low	(note 4, 9)	0		0.4V <sub>CC</sub>	V	Divide by 64 or 65	
Max. sinewave input frequ	2100			MHz	See Figure 5		
Min. sinewave input freque	ency			200	MHz	See Figure 5	
Min. RF input voltage			50	mV RMS	RF input 200MHz to 2100MHz. See Figure 5		
Max. RF input voltage	200			mV RMS	RF input 200MHz to 2100MHz. See Figure 5		
Output level (pin 4)		500	600		mV p-p		
Modulus set-up time, t <sub>s</sub>	10			ns	RF input = 1GHz		
Modulus hold time, t <sub>h</sub>			1	ns	RF input = 1GHz		
Power down time, t <sub>pd</sub>	(notes 7,8)			10	μs	See Figure 9	
Power down recovery time			8	μs	See Figure 9		

NOTES

All electrical testing is performed at +85°C.
 Typical values are measured at +25°C and V<sub>CC</sub> = +5V.
 Modulus Control and Ratio Select are high impedance inputs which can be driven directly by standard CMOS outputs.

5. Modulus control is latched at the end of the previous cycle.

6. See Figure 4.7. See Figure 8.

8. These parameters are not tested but are guaranteed by design.

9. The ratio select pin is not intended to be switched dynamically.

# **OPERATING NOTES**

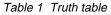
The RF inputs are biased internally and are normally coupled to the signal source with suitable capaitors.

The output stage has a novel design and is intended to drive a CMOS synthesiser input. External pull-down resistors or circuits are not required. The SP8714 is <u>not</u> suitable for driving TTL or similar devices.

The device will operate down to DC frequencies for non-sinusoidal signals provided that the input slew rate is better than 100V/µs.

POWER DOWN (pin 7) is connected internally to a pull-up resistor. If the battery economy facility is not used, pin 7 should be connected to V<sub>EE</sub>.

Ratio Select (Pin 3)	Modulus Control (Pin 6)	Division Ratio		
L	L	65		
L	Н	64		
н	L	33		
н	Н	32		



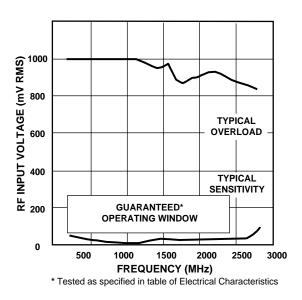


Fig. 3 Typical input characteristics

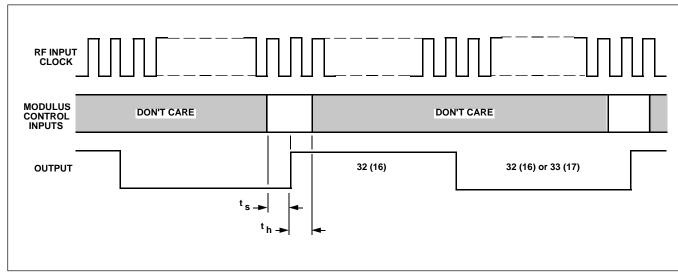


Fig. 4 Modulus control timing diagram

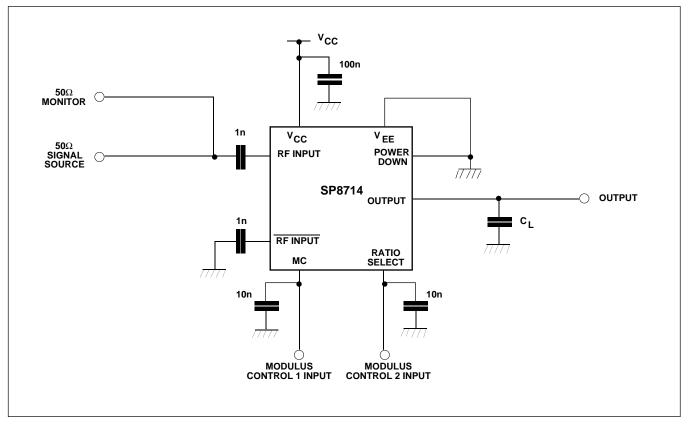


Fig. 5 Toggle frequency test circuit

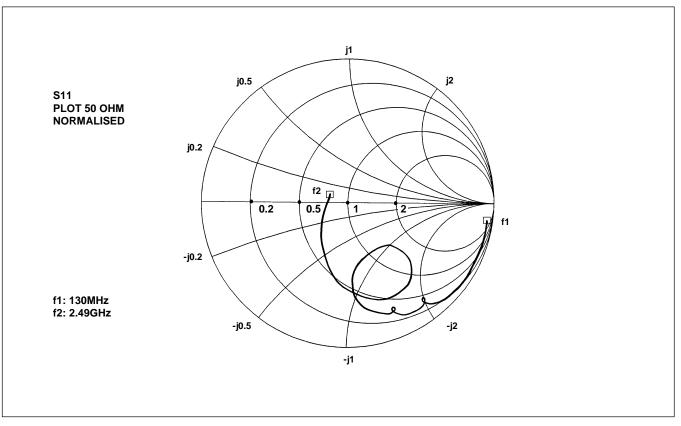


Fig. 6 Typical S11 parameter for pin 1.  $V_{CC} = +5.0V$ 

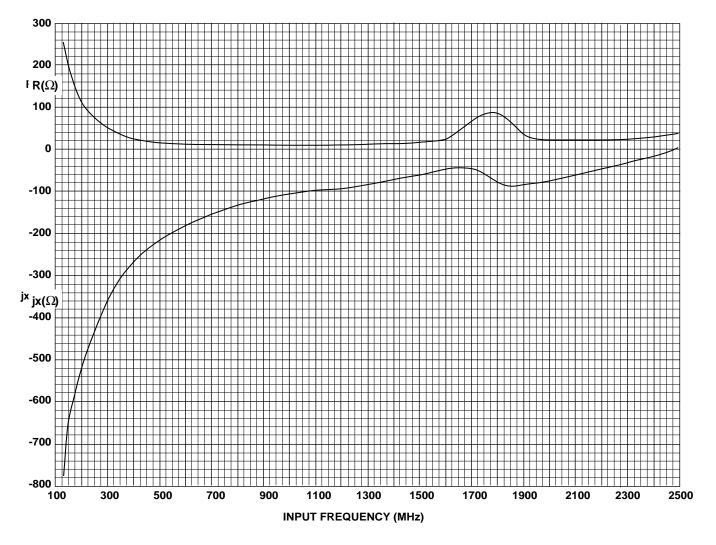
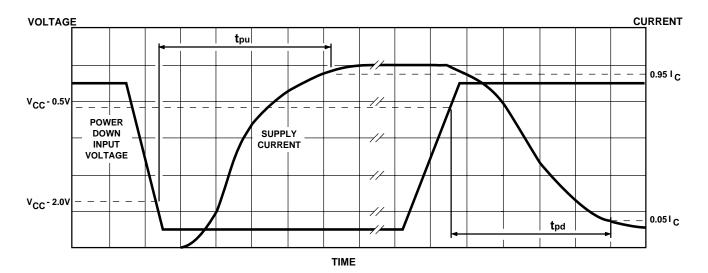


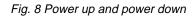
Fig. 7 Typical input impedance v. frequency

FREQ-MHZ	R (Ω)	jx (Ω)
130.000	255.068	-733.538
177.200	153.330	-583.339
224.400	88.649	-482.377
271.600	71.050	-411.502
318.800	39.526	-346.620
366.000	38.779	-304.804
413.200	23.809	-269.674
460.400	27.545	-245.161
507.600	22.227	-224.572
554.800	17.767	-203.241
602.000	14.607	-186.545
649.200	13.075	-174.839
596.400	12.583	-160.468
743.600	10.213	-149.642
790.800	11.269	-143.144
838.000	10.509	-132.750
885.200	10.172	-124.495
332.400	10.841	-118.100
979.600	12.260	-109.552
1026.80	14.508	-103.110
1074.00	19.260	-98.149
1121.20	23.285	-99.907
1168.40	18.956	-99.639
1215.60	14.377	-95.033
1262.80	12.711	-89.249
1310.00	12.598	-82.581
1357.20	14.565	-77.212
1404.40	19.164	-71.976
1451.60	15.001	-70.250
1498.80	15.864	-61.898
1546.00	18.993	-53.403
1593.20	26.822	-44.704
1640.40	39.830	-41.522
1687.60	47.875	-43.255
1734.80	63.267	-44.879
1782.00	74.259	-67.801
1829.20	58.878	-86.964
1876.40	42.530	-87.052
1923.60	32.302	-80.484
1970.80	27.333	-73.570
2018.00	24.894	-67.291
2065.20	23.369	-60.620
2112.40	23.577	-54.716
2159.60	23.023	-49.220
2206.80	23.325	-43.340
2254.00	24.623	-37.163
2301.20	26.340	-30.805
2348.40	28.632	-24.040
2395.60	31.161	-17.165
2442.80	34.219	-8.172
2490.00	39.808	-4.368

Table.2 Coefficients for Fig.7

# SP8714





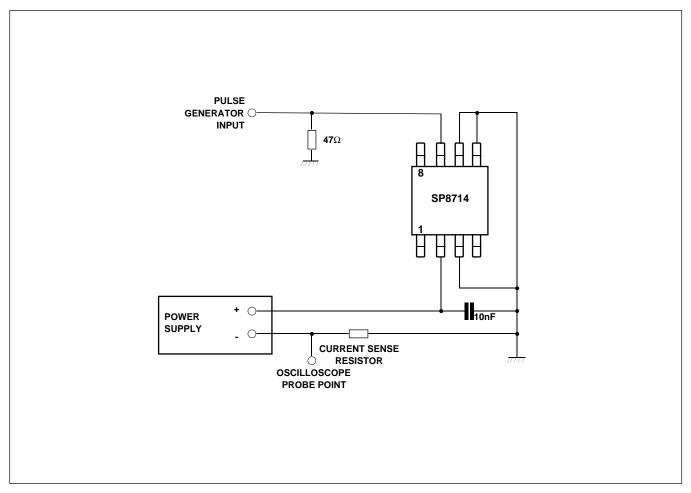
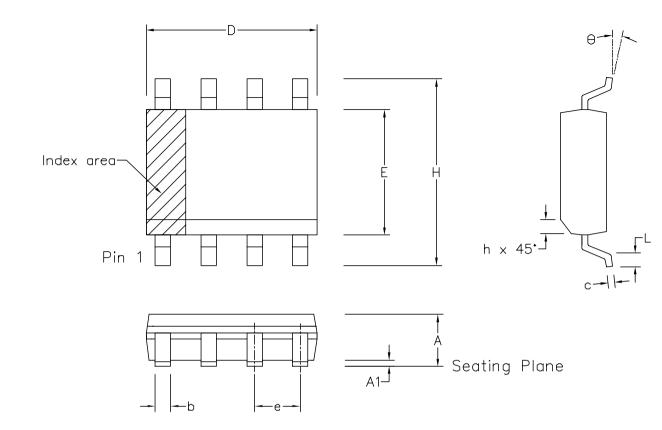


Fig. 9 Power-down time test circuit



	Min	Max	Min	Max	
	mm	mm	inch	inch	
A	1.35	1.75	0.053	0.069	
A1	0.10	0.25	0.004	0.010	
D	4.80	5.00	0.189	0.197	
Н	5.80	6.20	0.228	0.244	
E	3.80	4.00	0.150	0.157	
L	0.40	1.27	0.016	0.050	
е	1.27	BSC	0.050 BSC		
b	0.33	0.51	0.013	0.020	
С	0.19	0.25	0.008	0.010	
0	٥	8°	0°	8°	
			0 04 0		
<u>h</u>	0.25	0.50	0.010	0.020	
h	0.25		<u>0.010</u> eatures	0.020	
h N			eatures	3	

# Notes:

- 1. The chamfer on the body is optional. If it not present, a visual index feature, e.g. a dot, must be located within the cross-hatched area.
- 2. Controlling dimension are in inches.
- Dimension D do not include mould flash, protusion or gate burrs. These shall not exceed 0.006" per side.
  Dimension E1 do not include inter-lead flash or protusion. These shall not exceed 0.010" per side.
  Dimension b does not include dambar protusion/intrusion. Allowable dambar protusion shall be 0.004"
- total in excess of b dimension.

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